

INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Industrial networks – Single-drop digital communication interface –
Part 2: Functional safety extensions**

**Réseaux industriels – Interface de communication numérique point à point –
Partie 2: Extensions de sécurité fonctionnelle**

<https://standards.iteh.ai/catalog/standards/sist/18436671-141f-44e4-8643-6aafa3af3169/iec-61139-2-2022>



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The text of this International Standard is based on the following documents:

Draft	Report on voting
65C/1168/FDIS	65C/1174/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

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